

### HTS Metal-Insulated technology development at CEA towards HFM 20 T dipole magnets



CEA-CERN HFM collaboration agreement on HTS MI dipoles developments WP2.11

<u>Thibault Lécrevisse</u> (CEA) on behalf of HFM HTS team Amalia Ballarino (CERN)



## **Overview**

#### **1. Program introduction**

Program philosophy HTS development plan Two-years project planning

#### **2.** Numerical modelling

Introduction : some MI Racetrack possibilities Tools overview PEEC-R model and examples Salome / CASTEM FEM model Mechanical structure conception

#### **3. Experimental developments**

Developments and Characterization to be done Radial thermal conductivity characterization Electrical connection developments First small MI pancake coil with copper rings Effect of thermal cycles on HTS and joints Racetrack winding development

#### **4.** Perspectives

Models validation Concept validation



## Program introduction

1.1. Program philosophy
 1.2. HTS development plan
 1.3. Two-years project planning

## **1. HTS high field dipole development Philosophy**



#### **1. HTS high field dipole development plan**



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#### **1.** Planning



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# **2** Numerical modelling

- 2.1. Introduction : some MI Racetrack possibilities
- 2.2. Tools overview
- 2.3. PEEC-R model and examples
- 2.4. Salome / CASTEM FEM model
- 2.5. Mechanical structure conception

## **2.1. Introduction : some MI Racetrack possibilities**

Para	Unit	Value	
	Thickness	μm	72
	Width	mm	4
REBCO Tape (SST)	I <sub>c</sub> , 77 K, SF	А	> 210
(001)	I <sub>c</sub> , 4.2 K, 20 T //c A		> 460
	Unit Length	m	100-200
Durnamar	Thickness	μm	30
Dumomage	Width	mm	4
	Straight part length	mm	300 - 900
Racetrack	Width	mm	30
	Unit length	m	60-100-200

## **2.1. Introduction : some MI Racetrack possibilities**

Parameter	Unit	Case 1	Case 2	Case 3	Case 1	
Width	mm	30	30	30	Case 2	
S. Part length	mm	900	600	300	Case 3	- 95
# turns	-	103	148	257		
Inductance	mH	10.2	13.6	20.7		- 90 달
B at center	mT/A	2.07	2.72	3.99	$C_{2220} 2 : 1450 A / 4 2 K$	action
B peak	mT/A	6.99	8.24	10.32	Case S. 1430 A/ 4.2 K	dline Fr
I <sub>max, 4.2 K</sub>	А	1575	1545	1510		- 80 - 80
B <sub>center,max</sub> 4.2 K	т	3.26	4.20	6.02	Design accuracy ?	- 75
J <sub>e</sub> , max 4.2 K	A/mm²	3860	3785	3700	<ul> <li>Mechanics ?</li> <li>Cooling ?</li> </ul>	
		Pro	otectio	on?	<ul> <li>Protection ? MI parameters ?</li> <li>Fabrication ?</li> </ul>	







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## **2.3. PEEC-R model and examples**



#### **Geometrical study**

- □ 60 m tape
- 2 Racetracks
- 0.5 mm spacer
- □ Nb turns = [101;60;43;84;53;39]
- $\Box$  R<sub>ct</sub>=300 m $\Omega$ .cm<sup>2</sup>
- □ 1 sector damaged at 5 ms
- Adiabatic (T<sub>i</sub> = 4.2 K)
   1 V PS Voltage limitation
   85% of I<sub>max</sub> [228;249;265;236;255;271]
  - Thermal diffusion effect
     Results are depending on the number of turns



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## 2.4. Salome / CASTEM FEM model

Static thermal model (CASTEM) Half of the racetrack Copper 2 Current leads -2.1e+01 - 20 - 18 - 16 - 14 HTS 12 10 Constant heat source 4.2e+00 in the racetrack Max: 21.0 Min: 4.2 Constant Copper temperature T = 4.2 K



Nonlinear materials used for:

- HTS tapes (Stainless Steel + copper),
- copper current leads and cooling interfaces
- G10 insulation layers
- Stainless steel structure
- Orthotropic thermal conductivity in the HTS racetrack
- Homogeneous thermal conductivity in the copper
- Homogeneous and constant heat source in HTS

Volumic losses due to Radial current (ramping) AC losses (ramping) Local losses due to

 $\succ$  Electrical connections ( $\propto$  I<sup>2</sup>)



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## **2.4. Salome / CASTEM FEM model**



Static thermal model with structure (CASTEM)





Requirements :

Mechanics (few Tesla racetrack coil / magnet)
 Cooling (possibility of conduction cooling)
 Electrical connection (pressed copper rings and plates)
 Instrumentation (localized voltage taps, Cernox, Hall probes...)
 Modularity (number of Racetrack, size tolerances)



Mechanics, modularity  $\bigcirc$ Cooling & Current leads Electrical Connections

#### **R&D** Racetrack structure dimensioning

Para	Unit	Value	
	Thickness	μm	72
REBCO Tape	Width	mm	4
	Unit Length	m	60
Durnomag® Tape	Thickness	μm	30
	Width	mm	4
	Straigth part length	mm	140
	Width	mm	25
Coil Geometrical parameters	# Turns	-	142
	# Racetrack	-	2
	Distance between R	mm	1.8





**R&D Racetrack structure dimensioning** 

#### Stress on winding :

- > Cooling (300 K  $\rightarrow$  4.2 K)
- Magnetic (1000 A)
- Without pre-stress



E. Benoisi

#### Remarks:

- Acceptable stresses
- Risk of contact loss at some locations

Need to take into account the pre-stresses to avoid local contact loss.



Radial stress (MPa)

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L. Scola

**R&D Racetrack structure dimensioning** 

#### Stress on Structure :

- > Cooling (300 K  $\rightarrow$  4.2 K)
- Magnetic (1000 A)
- Without pre-stress



#### Remarks:

- ➢ Below 250 MPa
- Some approximation on screws

Some local over-stresses or lost of contact need to be investigate but results are encouraging for the prototyping





## **2. Summary on numerical developments**

Normal Transient

✓ Current redistribution → PEEC-R
 ✓ Radial losses → PEEC-R
 ✓ Cooling → SALOME / CASTEM
 ○ Mechanics → SALOME / CASTEM
 × Magnetisation → investigation ongoing

□ Fault Case (Quench)

✓ Current redistribution → PEEC-R
 ✓ Radial losses → PEEC-R
 ✓ Protection (voltage limitation) → PEEC-R
 × Cooling → required ?
 Mechanics → SALOME / CASTEM
 × Magnetisation → required ?

High  $J_e \rightarrow$  milliseconds quench  $\rightarrow$  Cooling not required ? Protection  $\rightarrow$  Voltage limitation  $\rightarrow$  Unbalanced forces? Normal transient  $\rightarrow$  Ratio AC and radial losses ?

Models require experimental validation

## **B Experimental developments**

3.1. Developments and Characterization to be done

- 3.2. Radial thermal conductivity characterization
- 3.3. Electrical connection developments
- 3.4. First small MI pancake coil with copper rings
- 3.5. Effect of thermal cycles on HTS and joints
- 3.6. Racetrack winding development

## **3.1. Developments and Characterization to be done**



https://theses.hal.science/tel-03946319



A. Blondelle

E. Benoist

C Genot

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G Lenoir

02/05/2024

#### Almost all has already started but results in S2 2024

## **3.2. Radial thermal conductivity characterization**



## **3.3. Electrical connection developments**



- Copper Ring : Bulk or soldered tape
- Copper Copper with or w/o Indium
- With or w/o graphene
- Effect of pressure
- Effect of copper roughness
- Mechanical cycles
- Thermal cycles (77 K)
- Copper quality
  - For now about 0.8 μΩ.cm<sup>2</sup> with Indium
    → ~ 200 nΩ on our samples

**Optimize** the contact resistance and evaluate the **required contact area** for each application

## **3.4. First small MI pancake coils with copper rings**



Started : first windings done



Inner ring : 3 mm thick, OD 41 mm Outer ring : 3 mm thick (100 µm copper tape) HTS Winding : 50 turns



## Tests to be done in the next months



Noninsulated coils



Metalinsulated coils

## **3.5. Effect of thermal cycles on HTS and joints**



## **3.6. Racetrack winding development**





Example of Copper/Durnomag winding test



Example of inner racetrack copper connection



## MI racetrack winding with copper "rings" developments just started

## **3.6. Racetrack winding development**

Understand the stresses and related parameters



o Measurements



Instrumented racetrack with strain gages

Analytical model





## **3. Summary on experimental developments**

#### 

- MI radial conductivity
  - ✓ setup (design & fabrication)
  - ✓ First sample tested
  - Validation on known material
  - MI Stack study
- Joints thermal degradation
  - ✓ Setup (design & fabrication)
  - o 77 K critical current setup
  - Thermal effect Study

Technological Developments

- Integrated current leads
  - ✓ Winding on copper rings (bulk)
  - ✓ Fabrication of outer ring (soldered tape)
  - Pressed copper rings study
  - Fabrication of racetrack copper rings
  - $\circ~$  Stack of HTS pancakes
  - Stack of HTS racetracks
- Racetrack windings
  - ✓ Tooling fabrication
  - $\circ~$  Fabrication process on short racetrack
  - Tension effect study
  - $\circ$  600-900 mm racetrack winding



4.1. Models validation4.2. Concept validation

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#### Preparation

- ✓ Evaluation of suitable racetrack geometries and stacking
- $\rightarrow$  140 mm Straight part, 25 mm width, 142 turns
- ✓ Estimate the number of samples
- → 10 to 14 Racetracks
- ✓ Design of the structure for test at 77 K (GN2/LN2) and 4.2 K (LHe)
- $\rightarrow$  See next slides and previous numerical modelling
- $\checkmark$  Develop the device to locally reduce the critical current on a tape
- → Presented after

What tests to do ? (under discussion)

- $\rightarrow$  Volontary local degradation
- → Fast current ramp
- $\rightarrow$  Ramp with steps
- → Step at 95% of critical current
- → Suddent discharge

#### Structure inside a cryostat













Structure with instrumentation











- Device to locally degrade the critical current
  - Degradation on 10 mm
  - Evaluate the degradation with couple [T°C; time]
  - □ Evaluate the reproductibility



Starting May 2024

## 4.2. Concept validation



Parameter	Unit	Case 1	Case 2	Case 3	
Width	mm	30	30	30	
S. Part length	mm	900	600	300	
# turns	-	103	148	257	
Inductance	mH	10.2	13.6	20.7	
B at center	mT/A	2.07	2.72	3.99	
B peak	mT/A	6.99	8.24	10.32	
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B <sub>center,max</sub> 4.2 K	Т	3.26	4.20	6.02	
J <sub>e</sub> , max 4.2 K	A/mm²	3860	3785	3700	
Protection ?					

#### Start to evaluate the final prototype

- > Consideration of I<sub>c</sub>, 4.2 K, 20 T //c > 460 A (4 mm)
- « Long racetrack » (600-900 mm)
- Fabrication of Two Single Racetracks
- One or two HTS tape « cable »?
- > Central Induction 3 4 T (SR) (5 6 T Double R)
- High current density (above 1500 A/mm<sup>2</sup>)
- > 77 K, 20 K (?), 4.2 K (?) (conduction or liquid?)







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Thibault LECREVISSE

Thibault.lecrevisse@cea.fr

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